



SBR3U60P1

# 3.0A SBR<sup>®</sup> SUPER BARRIER RECTIFIER POWERDI<sup>®</sup>

#### **Features**

- Ultra Low Forward Voltage Drop
- Superior Reverse Avalanche Capability
- Patented Interlocking Clip Design for High Surge Current Capacity
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 150°C Operating Junction Temperature
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### Mechanical Data

- Case: POWERDI123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Polarity Indicator: Cathode Band
- Terminals: Matte Tin Finish annealed over Copper leadframe.
   Solderable per MIL-STD-202, Method 208 63
- Weight: 0.018 grams (approximate)

#### POWERDI123



Top View

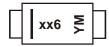
### **Ordering Information** (Note 4)

Part Number	Case	Packaging
SBR3U60P1-7	POWERDI123	3000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

# **Marking Information**



SV6, 3U6 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Key

Date Code Rey												
Year	201	1	2012		2013	20	14	2015		2016	2	2017
Code	Υ		Z		Α	Е	3	С		D		E
			1					_		_		_
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



## Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>RM</sub>	60	٧
RMS Reverse Voltage	V <sub>R(RMS)</sub>	42	V
Average Rectified Output Current (See Figure 1)	I <sub>O</sub>	3.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	80	Α

### **Thermal Characteristics**

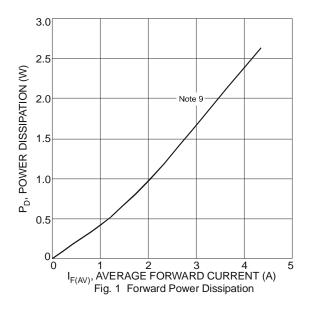
Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Thermal Resistance Junction to Soldering (Note 5) Thermal Resistance Junction to Ambient (Note 6) Thermal Resistance Junction to Ambient (Note 7)	$egin{array}{c} {\sf R}_{ heta {\sf JS}} \ {\sf R}_{ heta {\sf JA}} \ {\sf R}_{ heta {\sf JA}} \end{array}$	5 175 100	°C/W
Operating and Storage Temperature Range (Note 8)	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

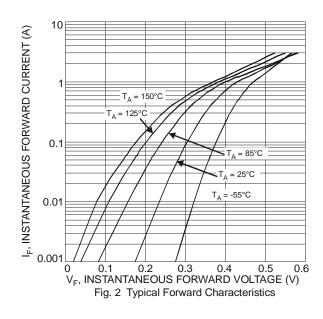
# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	VF	•	-	0.650	V	I <sub>F</sub> = 3.0A, T <sub>J</sub> = 25°C
Leakage Current (Note 8)	$I_R$	-	-	100	μA	$V_R = 60V, T_J = 25^{\circ}C$

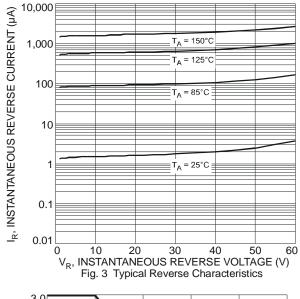
Notes

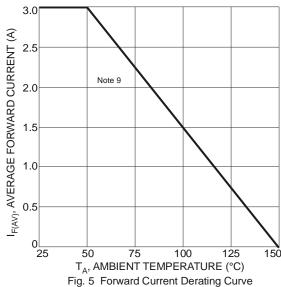
- 5. Theoretical R<sub>0JS</sub> calculated from the top center of the die straight down to the PCB cathode tab solder junction.
- 6. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 7. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Polymide substrate, 10cm x 10cm copper, double-sided PC board.

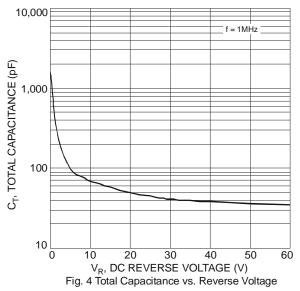


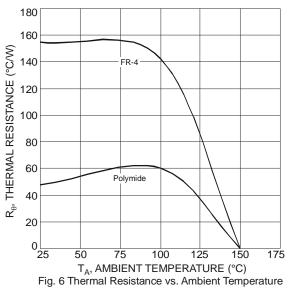




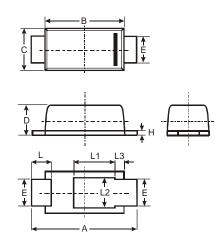








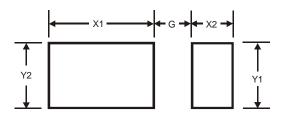
# **Package Outline Dimensions**



POWERDI123							
Dim	Min	Max	Тур				
Α	3.50	3.90	3.70				
В	2.60	3.00	2.80				
С	1.63	1.93	1.78				
D	0.93	1.00	0.98				
Е	0.85	1.25	1.00				
Н	0.15	0.25	0.20				
L	0.40	0.50	0.45				
L1	-	-	1.35				
L2	-	-	1.10				
L3	-	-	0.20				
All Dimensions in mm							



## **Suggested Pad Layout**



Dimensions	Value (in mm)
G	1.0
X1	2.2
X2	0.9
Y1	1.4
Y2	1.4

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